

PRODUCT NUMBER  
10121021-Y01-02LF

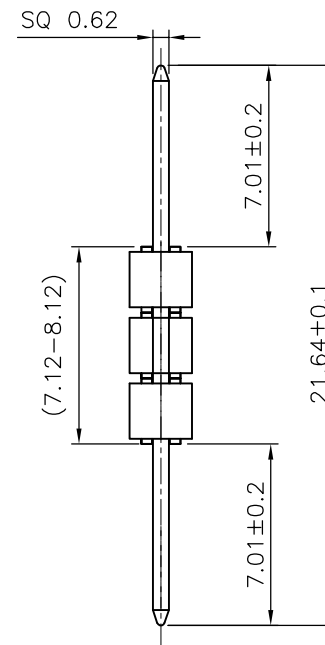
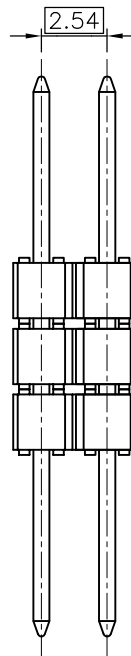
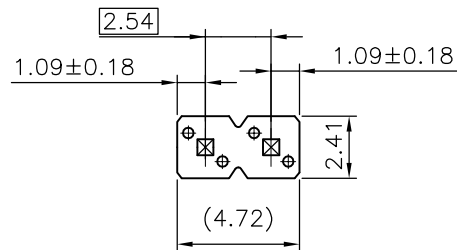
RoHS COMPATIBLE, SEE NOTE 5  
NUMBER OF CONTACTS  
PIN STYLE

PLATING

4 = 2µm TIN MIN OVER 1.27µm Ni MIN  
8 = 0.38µm GOLD/GXT OVER 1.27µm Ni MIN

NOTES:

1. HOUSING MAT'L : HIGH TEMPERATURE THERMOPLASTIC. UL94V-0 COLOR CREAM.
2. PIN MATERIAL : PHOSPHOR BRONZE.
3. 9N MIN RETENTION IN EITHER DIRECTION.
4. STANDARD PACKAGING IN POLYBAG
5. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
  - a - PLATING:
    - "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.
  - b - MANUFACTURING PROCESS COMPATIBILITY
    - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
  - c - LABELING:
    - MEETS PACKAGING SPECS AS PER GS-14-920
  - d - LEGAL STATEMENT: SEE GS-47-0004



mat'l. code		surface		tolerance		projection		product family	
		ISO 1302		ISO 406 ISO 1101				BSTIK	
ltr		ecn no		dr		date		title	
A		F12-0816		LMU		12.10.18		HEADER STR,SR TRIPLE BODY	
B		B-16483		LMU		13.12.10			
C		B-19562		BVE		14.11.27		dwg no 10121021	
D		B-19782		AMA		14.12.16		sheet 1 of 1 size A3	
				dr		L MULIN 12.05.09		type CUSTOMER Drawing	
				enr		A PARRENIN 12.05.09			
				chr		JCO 12.05.09			
				appd					
sheet index		revision sheet							